

Data sheet

Title: FIXED CHIP RESISTORS; RECTANGULAR TYPE & WIDE TERMINATION - LOW OHM

Style: TWLC32,50,63

RoHS COMPLIANCE ITEM
Halogen and Antimony Free

- Note:
- Stock conditions
Temperature: +5°C ~ +35°C
Relative humidity: 25% ~ 75%
The period of guarantee: Within 2 year from shipment by the company.
Solderability shall be satisfied.
 - Product specification contained in this data sheet are subject to change at any time without notice
 - If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.



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1. Scope

1.1 This data sheet covers the detail requirements for fixed chip resistors; rectangular type & wide termination - low ohm, style of TWLC32, 50, 63.

1.2 Applicable documents

JIS C 5201-1: 2011S C 5201-8: 2014, JIS C 5201-8-1: 2014
 IEC60115-1: 2008, IEC60115-8: 2014, IEC60115-8-1: 2014
 EIAJ RC-2134C-2010

2. Classification

Type designation shall be the following form.

(Example)

TWLC	50	-	R470	J	TE
1	2	3	4	5	6

 Style

1 Fixed thick film chip resistors; rectangular type and low ohm Style

2 Size

3 Temperature coefficient of resistance

-(Dash)	Standard
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4 Rated resistance Rated resistance and symbol shall be in accordance with Sub-clause 3.3.

R470	4 digit, Ex. R470--> 470mΩ,
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5 Tolerance on rated resistance

F	±1%
J	±5%

6 Packaging form

B	Bulk (loose package)
TP	Paper taping
TE	Embossed taping

3. Rating

3.1 The ratings shall be in accordance with Table-1.

Table-1

Style	Rated dissipation (W)	Rated current range (A)	Temperature coefficient of resistance (10 ⁻⁶ /°C)		Rated resistance range(Ω)	Tolerance on rated resistance
TWLC32	1.0	1.04~3.16	-(Dash)	0~+200	0.5~0.91	F(±1%), J(±5%)
				0~+250	0.2~0.47	
				0~+350	0.1~0.18	
TWLC50	1.0	1.04~3.16	-(Dash)	0~+200	0.2~0.91	F(±1%), J(±5%)
				0~+350	0.1~0.18	
TWLC63	2.0	1.48~4.47	-(Dash)	0~+200	0.2~0.91	F(±1%), J(±5%)
				0~+350	0.1~0.18	

Style	Limiting element voltage(V)	Insulation voltage (V)	Category temperature range (°C)
TWLC32	0.95	500	-55~+155
TWLC50	0.95		
TWLC63	1.34		

3.2 Rated resistance

The rated resistance shall be in accordance with Table-2

Table-2

Rated resistance		Rated resistance	
Rated resistance [mΩ]	Symbol	Rated resistance [mΩ]	Symbol
100	R100	400	R400
110	R110	430	R430
120	R120	470	R470
130	R130	500	R500
150	R150	510	R510
160	R160	560	R560
180	R180	600	R600
200	R200	620	R620
220	R220	650	R650
240	R240	680	R680
250	R250	700	R700
270	R270	750	R750
300	R300	800	R800
330	R330	820	R820
360	R360	900	R900
390	R390	910	R910

3.3 Climatic category 55/155/56

Lower category temperature -55 °C
Upper category temperature +155 °C
Duration of the damp heat, steady state test 56days

3.4 Stability class 5%

Limits for change of resistance:
-for long-term tests ±5%
-for short-term tests ±1%

3.5 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.

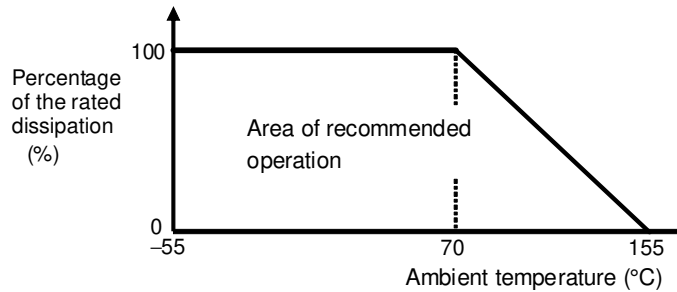


Figure-1 Derating curve

3.6 Rated voltage

d.c. or a.c. r.m.s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E = \sqrt{P \cdot R}$$

E: Rated voltage (V)

P: Rated dissipation (W)

R: Rated resistance (Ω)

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

3.7 Rated current

The rated current calculated from the square root of the quotient of the rated resistance and the rated dissipation.

$$I = \sqrt{P / R}$$

I: Rated current (A)

P: Rated dissipation (W)

R: Rated resistance (Ω)

The rated current shall be corresponding to rated voltage.

4. Packaging form

The standard packaging form shall be in accordance with Table-3.

Table-3

Symbol	Packaging form		Standard packaging quantity / units	Application
B	Bulk (loose package)		1,000 pcs.	TWLC32,50,63
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	TWLC32
TE	Embossed taping	12mm width, 4mm pitches	4,000 pcs.	TWLC50,63

5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-4.

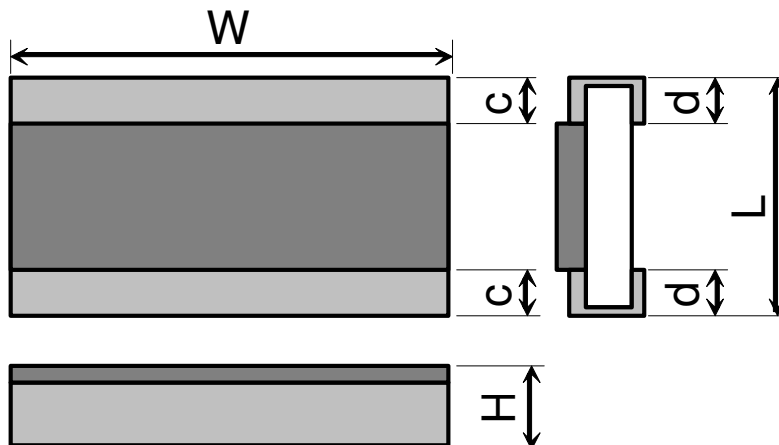


Figure-2

Table-4

Unit: mm

Style	L	W	H	c	d
TWLC32	1.6±0.2	3.2±0.2	0.55±0.10	0.5±0.25	0.5±0.25
TWLC50	2.5±0.15	5.0±0.2	0.55±0.10	0.6±0.2	0.6±0.2
TWLC63	3.2±0.2	6.3±0.2	0.6±0.1	0.6±0.2	0.6±0.2

6. Marking

The rated resistance shall be marked in 4 characters consisting of 3 figures or 3 figures and a letter and marked on over coat side.

(Example) "R100" → 0.1 [Ω]

7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201-1: 2011.

7.2 The performance shall be satisfied in Table-5.

Table- 5(1)

No.	Test items	Condition of test (JIS C 5201-1)	Performance requirements
1	Visual examination	Sub-clause 4.4.1 Checked by visual examination.	As in 4.4.1 The marking shall be legible, as checked by visual examination.
2	Dimension Resistance	Sub-clause 4.4.2 Sub-clause 4.5 Measurement current: 10(mA) Note: The measuring apparatus corresponding to Digital multimeter of TR6878 for Advantest Corp..	As specified in Table-4 of this specification. As in 4.5.2 The resistance value shall correspond with the rated resistance taking into account the specified tolerance.
3	Voltage proof	Sub-clause 4.7 Method: 4.6.1.4 Test voltage: Alternating voltage with a peak value of 1.42 times the insulation voltage. Duration: 60 s±5 s Insulation resistance Test voltage: Insulation voltage Duration: 1 min.	No breakdown or flash over R ≥ 1 GΩ
4	Solderability	Sub-clause 4.17 Without aging Flux: The resistors shall be immersed in a non-activated soldering flux for 2 s. Bath temperature: 245 °C±5 °C Immersion time: 2 s±0.5 s	As in 4.17.4.5 The terminations shall be covered with a smooth and bright solder coating.
5	Mounting Overload (in the mounted state) Solvent resistance of the marking	Sub-clause 4.31 Substrate material: Epoxide woven glass Sub-clause 4.13 The applied voltage shall be 2.5 times the rated voltage or the current corresponding to. Duration: 2 s Visual examination Resistance Sub-clause 4.30 Solvent: 2-propanol Solvent temperature: 23 °C±5 °C Method 1 Rubbing material: cotton wool Without recovery	No visible damage ΔR ≤ ±1% Legible marking

Table-5(2)

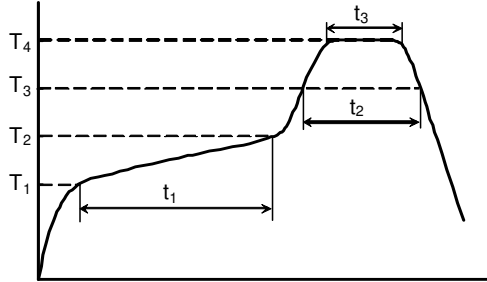
No	Test items	Condition of test (JIS C 5201-1)	Performance requirements
6	Mounting Bound strength of the end face plating Final measurements	Sub-clause 4.31 Substrate material: Epoxide woven glass Sub-clause 4.33 Bent value: TWLC32: 3mm TWLC50,63: 1 mm Resistance Sub-clause 4.33.6 Visual examination	$\Delta R \leq \pm 1\%$ No visible damage
7	Resistance to soldering heat Component resistance solvent	Sub-clause 4.18 (JEITA RC-2144 2.3.2) T ₁ :Pre-heat minimum temp.:150±5 °C T ₂ :Pre-heat maximum temp.:180±5 °C T ₃ :Soldering temp.:220 °C T ₄ :Peak temp.:250 °C t ₁ :Pre-heat duration:120±5 s t ₂ :Soldering duration:60 to 90 s t ₃ :Peak duration(T ₄ -5°C):20 to 40 s Pre-reflow soldering: 1 time (Initial measurements) Reflow soldering: 3 times  Visual examination Resistance Sub-clause 4.29 Solvent: 2-propanol Solvent temperature: 23 °C±5 °C Method 2 Recovery: 48 h Visual examination Resistance	No visible damage $\Delta R \leq \pm 1\%$ No visible damage $\Delta R \leq \pm 1\%$

Table-5(3)

No	Test items	Condition of test (JIS C 5201-1)	Performance requirements
8	Mounting Adhesion Rapid change temperature	Sub-clause 4.31 Substrate material: Epoxide woven glass Sub-clause 4.32 Force: 5 N Duration: 10 s±1 s Visual examination Sub-clause 4.19 Lower category temperature: -55 °C Upper category temperature: +155 °C Duration of exposure at each temperature: 30 min. Number of cycles: 5 cycles. Visual examination Resistance	No visible damage No visible damage $\Delta R \leq \pm 1\%$
9	Climatic sequence -Dry heat -Damp heat, cycle (12+12hour cycle) First cycle -Cold -Damp heat, cycle (12+12hour cycle) Remaining cycle -D.C. load	Sub-clause 4.23 Sub-clause 4.23.2 Test temperature: +155 °C Duration: 16 h Sub-clause 4.23.3 Test method: 2 Test temperature: 55 °C [Severity(2)] Sub-clause 4.23.4 Test temperature -55 °C Duration: 2h Sub-clause 4.23.6 Test method: 2 Test temperature: 55 °C [Severity (2)] Number of cycles: 5 cycles Sub-clause 4.23.7 The applied current shall be the rated current. Duration: 1 min. Visual examination Resistance	No visible damage No visible damage $\Delta R \leq \pm 5\%$
10	Mounting Endurance at 70 °C	Sub-clause 4.31 Substrate material: Epoxide woven glass Sub-clause 4.25.1 Ambient temperature: 70 °C±2 °C Duration: 1000 h The current shall be applied in cycles of 1.5 h on and 0.5 h. The applied current shall be the rated current Examination at 48 h, 500 h and 1000 h: Visual examination Resistance	No visible damage No visible damage $\Delta R \leq \pm 5\%$

Table-5(4)

No	Test items	Condition of test (JIS C 5201-1)	Performance requirements
11	Mounting Variation of resistance with temperature	Sub-clause 4.31 Substrate material: Epoxide woven glass Sub-clause 4.8 +20 °C / +155 °C	As in Table-1
12	Mounting Damp heat, steady state	Sub-clause 4.31 Substrate material: Epoxide woven glass Sub-clause 4.24 Ambient temperature: 40 °C±2 °C Relative humidity: 93 \pm ₃ % Without current applied. Visual examination Resistance	No visible damage Legible marking $\Delta R \leq \pm 5\%$
13	Dimensions (detail) Mounting Endurance at upper category temperature	Sub-clause 4.4.3 Sub-clause 4.31 Substrate material: Epoxide woven glass Sub-clause 4.25.3 Ambient temperature: 155 °C±2 °C Duration: 1000 h Examination at 48 h, 500 h and 1000 h: Visual examination Resistance	As in Table-4 No visible damage $\Delta R \leq \pm 5\%$

8. Taping

8.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010

8.2 Taping dimensions

8.2.1 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-6.

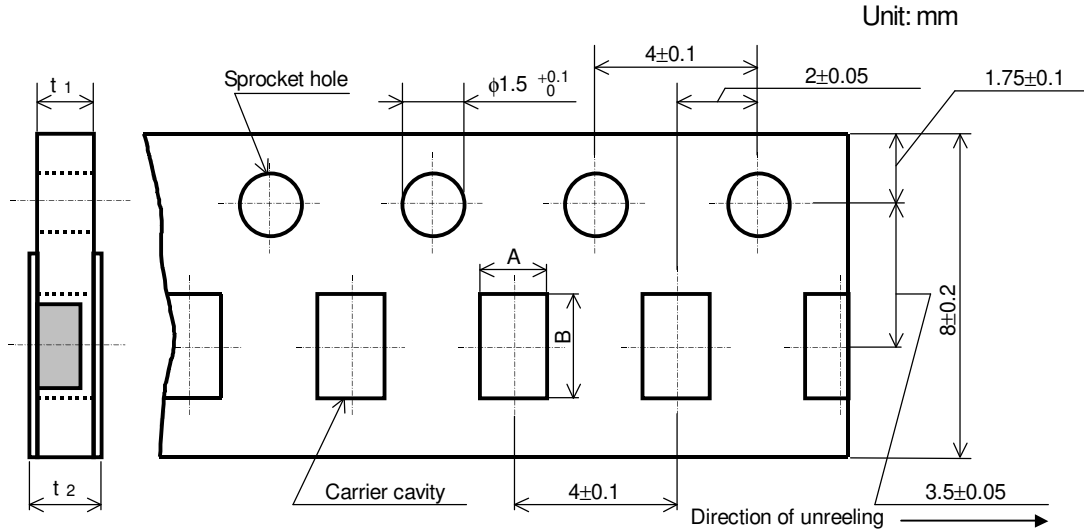


Figure-3

Table-6

Unit: mm

Style	A	B	t ₁	t ₂
TWLC32	2.00±0.15	3.6±0.2	0.8±0.1	1.0max.

8.2.2 Embossed taping dimensions shall be in accordance with Figure-4 and Table-7.

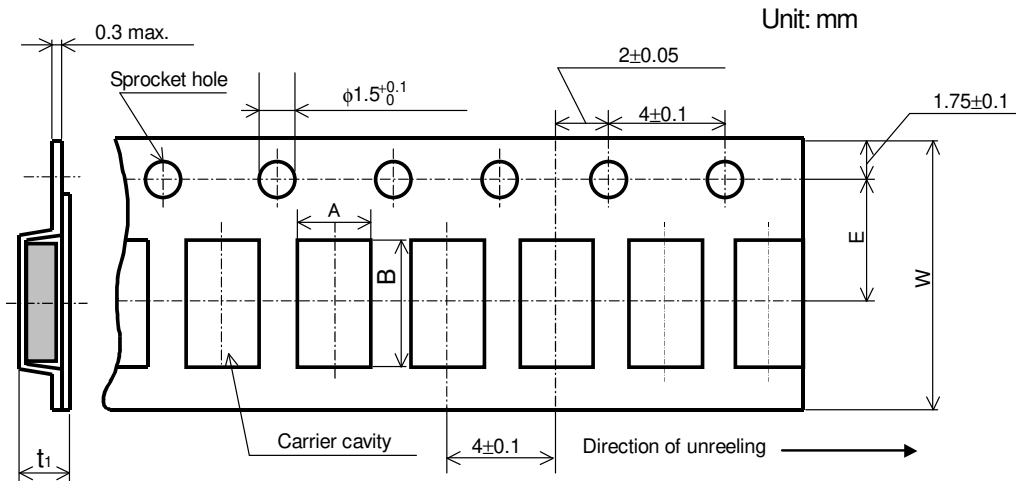


Figure-4

Table-7

Unit: mm

Style	A	B	W	E	t ₁
TWLC50	3.1±0.2	5.5±0.2	12±0.3	5.5±0.05	1.1±0.15
TWLC63	3.6±0.2	6.9±0.2			

- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches $\pm 0.2\text{mm}$.
- 5). The peel strength of the top cover tape shall be within 0.1N to 0.5N on the test method as shown in the following TWLC32: Figure-5, TWLC50,63: Figure-6.
- 6). When the tape is bent with the minimum radius for (TWLC32: 25mm, TWLC50,63: 30mm) the tape shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.
The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.

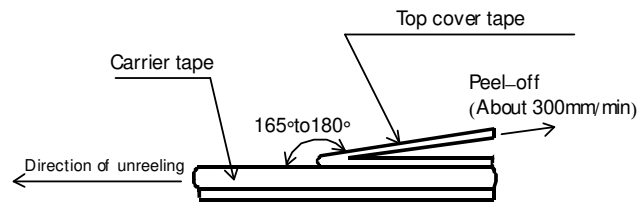


Figure-5

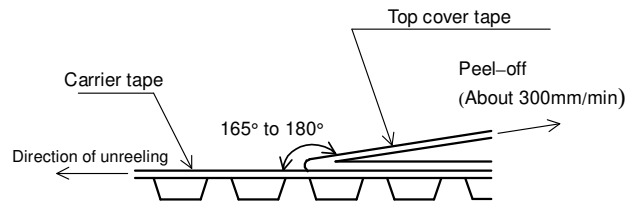


Figure-6

8.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure-7 and Table-8.

Plastic reel (Based on EIAJ ET-7200C)

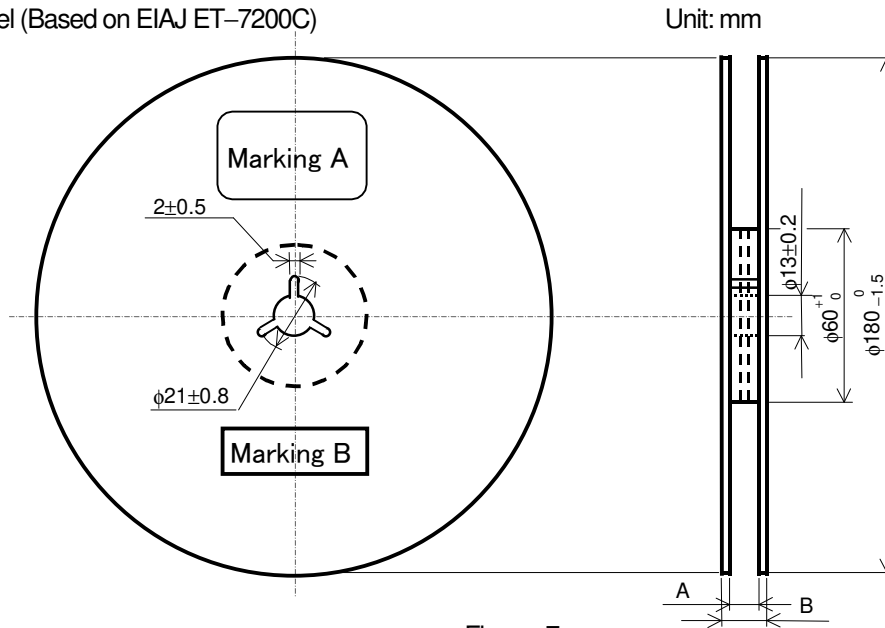


Figure-7

Table-8

Unit: mm

Style	A	B	Note
TWLC32	9 ^{+1.0} ₀	11.4±1.0	Injection molding
		13±1.0	Vacuum forming
TWLC50,63	13 ^{+1.0} ₀	17±1.0	Vacuum forming

Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

8.4 Leader and trailer tape.

(Example)

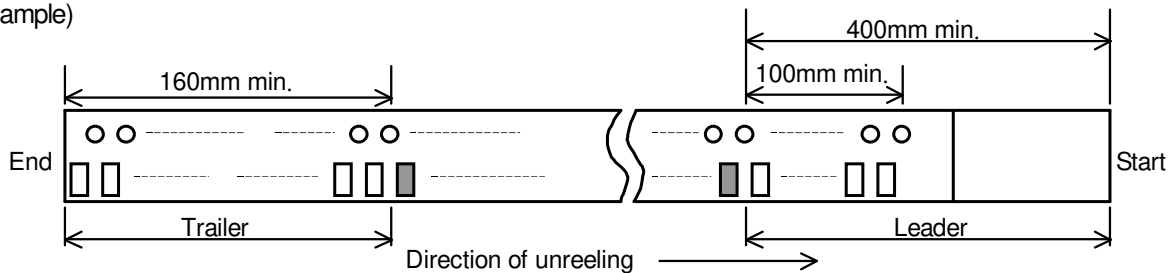


Figure-8

9. Marking on package

The label of a minimum package shall be legibly marked with follows.

9.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

(2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others

9.2 Marking B (KAMAYA control label)